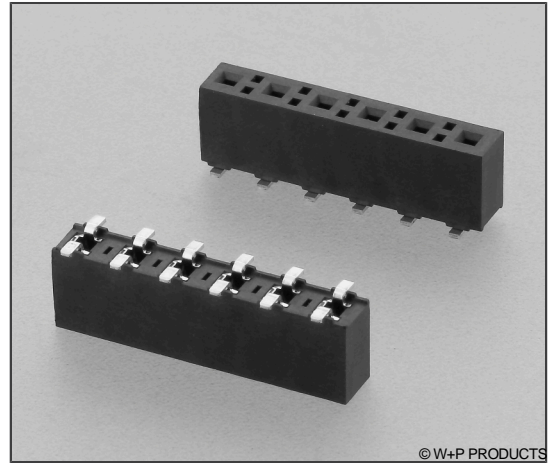


SMT-Buchsenleisten RM 5,08mm, stehend – Power-Kontakte, durchsteckbar SMT Female Headers, 5.08mm Pitch, Vertical – Power Contacts, Pass Through

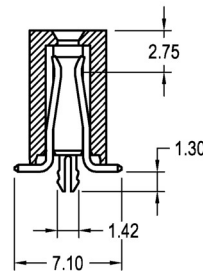
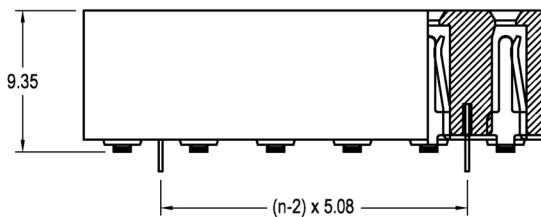
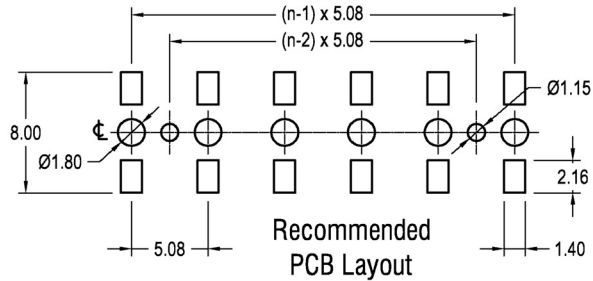
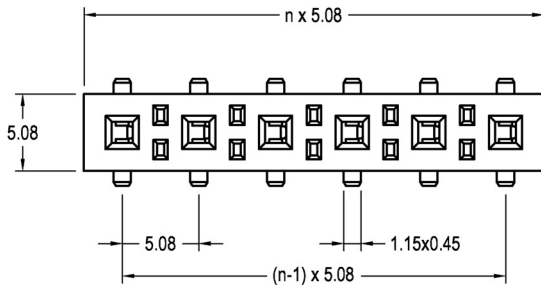
Technische Daten / Technical Data

Isolierkörper	Thermoplast, nach UL94 V-0
Insulator	Thermoplastic, rated UL94 V-0
Kontaktmaterial	Kupferlegierung
Contact Material	Copper alloy
Kontaktoberfläche	Lt. Oberflächenoptionen, über Ni (1,3 ... 2,5µm)
Contact Surface	Acc. to options (see below), over Ni (1.3 ... 2.5µm)
Durchgangswiderstand	< 10 mΩ
Contact Resistance	< 10 mΩ
Isolationswiderstand	> 500 MΩ
Insulation Resistance	> 500 MΩ
Spannungsfestigkeit	500 V AC
Test Voltage	500 V AC
Nennstrom	7,9 A
Current Rating	7.9 A
Temperaturbereich	-40 °C ... +125 °C
Temperature Range	-40 °C ... +125 °C
Verarbeitung	Reflow-Lötverfahren
Processing	Reflow soldering



© W+P PRODUCTS

Passende Stiftleisten:
Compatible Pin Headers:
985 986 9850 9860



Series	Contacts*	Plating*	Board Locks*	Packaging*
3950	05	50	00	ST
	02-20	00 Vergoldet Gold plated 50 Verzinkt Tin plated 60 Sel. Au/Sn Duplex plating	00 Ohne Board Locks W/o board locks 10 Mit Board Locks With board locks	ST PPST PPTR

Lieferformen / Packaging Options:

ST In Stangen ohne Pick&Place-Pads / In tubes w/o Pick&Place-Pads
PPST In Stangen mit P&P-Pads / In tubes with P&P-Pads
PPTR Tape & Reel mit P&P-Pads / Tape & Reel with P&P-Pads

* Dies ist ein **Bestellbeispiel** - bitte durch Ihre Spezifikationen ersetzen.
* This is an **order example** - please replace by your specifications.